



LHC Injectors Upgrade





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Beam Loss Monitoring & Observation

Review of the development, installation and commission plans



Global Overview

| Machine/Area | | Documentation | Detectors | Electronics | Installation & Commissioning | Budget | Expected |
|--------------|---------------------|----------------|------------|-------------|------------------------------|----------------|----------|
| PSB | Ring (L2 position) | Complete | LHC-IC | Pre-series | On-track | Incomplete | LS1 |
| | Injection & BI Line | Complete | LHC-IC/LIC | Pre-series | Initialising plan | Incomplete | L4C |
| | Injection (obser.) | Complete | Diamond | TBD | Initialising plan | Incomplete | L4C |
| | Ring (L3 position) | Complete | FIC | Series | Not started | Incomplete | LS2 |
| | Extraction | Complete | LHC-IC | Series | Not started | Incomplete | LS2 |
| PS | Ring | Only positions | LHC-IC | Series | Not started | Unallocated | TBD |
| | Ring (observation) | Only positions | Diamond | TBD | Not started | Unallocated | TBD |
| | Transfer Lines | Only positions | LHC-IC | Series | Not started | Unallocated | TBD |
| SPS | Ring & Tr. Lines | Advanced | SPS-IC | TBD | Not started | to be verified | LS3 |
| | TT10 | Complete | LHC-IC | Series | Not started | Unallocated | TBD |

- Plans for **LS1 & L4 Connection** are clear and agreed.
 - Update of budget needed (times and amounts).
 - Will validate pre-series version of electronics with beam.
- Plans for **LS2** and beyond need input and budgets (inc. manpower).



Specifications



Specifications

- **Detector** types and quantities to be used – all defined.
- **Cables** and connections – majority has already been sent to EN/EL.
- **Electronics**
 - use the [pre-series production](#) for LS1 and L4 connection needs.
 - use [series production](#) for LS2+ (i.e. validate electronic design beforehand).
 - acquisition system for Diamond detectors under [study](#).
 - acquisition system for SPS system under [study](#).

| Machine/Area | | | Detectors | | Cables | | Electronics | |
|--------------|---------------------|----------|------------|--------|--------|--------|-------------|--------|
| | | Channels | Type | Budget | DIC | Budget | Type | Budget |
| PSB | Ring (L2 position) | 32 | LHC-IC | Spares | Sent | LIU | Pre-series | CONS |
| | Injection & BI line | 18 | LHC-IC/LIC | Spares | Sent | LIU | Pre-series | LIU |
| | Injection (obser.) | 8 | Diamond | LIU | Draft | LIU | TBD | LIU |
| | Ring (L3 position) | 32 | FIC | LIU | Sent | LIU | Series | CONS |
| | Extraction | 28 | LHC-IC | Spares | Sent | LIU | Series | LIU |
| PS | Ring | 100 | LHC-IC | LIU | Sent | LIU | Series | LIU |
| | Ring (observation) | 40 | Diamond | LIU | Draft | LIU | TBD | LIU |
| | Transfer Lines | 51 | LHC-IC | LIU | Sent | LIU | Series | LIU |
| SPS | Ring + Tr. Lines | 500 | SPS-IC | Re-use | TBD | LIU | TBD | LIU |
| | TT10 | 30 | LHC-IC | LIU | Sent | LIU | Series | LIU |



Acquisition & Processing

- **Synchronisation is required with the start of the cycle to**
 - Perform calculation of integration periods and
 - Schedule comparisons with their corresponding threshold values
 - Record high frequency observation data
 - Schedule the data readout and publish by the CPU
- **Synchronisation to be achieved by**
 - Use the Start of Cycle event received through the timing system.
 - **Dedicated timing card** with broadcast in the backplane.
 - Sync will be done at the processing level (i.e. 2 samples jitter between cards).



Integration Periods

Continuously the processing electronics will calculate 4 **integration period values** for each channel:

- **2 μ s, 400 μ s, 1 ms and 1.2 s** (full cycle)
 - implemented as moving sum windows in the hardware
 - calculation refreshed at acquisition frequency
- Compare with predefined thresholds
 - **Machine protection** with **hardware** implementation comparisons on each refresh
 - **Limit radiation levels** with **software** implementation comparisons at end of cycle
 - See also next slide.
- Calculate for each channel the **maximum** values recorded on each integration period during the cycle
 - Publish them for the online displays and
 - the long-term logging



Threshold Comparisons

Hardware implementation part:

- All **calculated integration period values**, i.e from **2 μ s** to **1.2 s**, will be constantly checked against their threshold values:
 - 4 threshold values, one for each of the integration periods.
 - Comparisons happen at the refresh period – that is, every 2 μ s
 - In the case the measured values exceed those the **beam permit signal** will be removed for **all users**
 - The **blocked** beam permit signal will be **latched** until an operator acknowledges.
- The **threshold values** will be need to be set **unique per channel**:
 - Each card will process 8 channels

Software implementation part:

- All **maximum integration period values** recorded on the cycle will be checked against a second set of threshold values. The outputs will be used for **repeated over threshold function**
 - Additional threshold values for the same integration periods will also be required.
 - In the case found to be **over threshold repeatedly n times** it will be required to block **that user's injections**.
 - The **blocked** beam permit signal will be **latched** until an operator acknowledges.
 - The repeat value n will be settable per monitor in the range of 1 to 16.
- The **threshold values** will need to be **unique per user and per channel**:
 - Each CPU will process 8 cards x 8 channels
 - The information of the current user has to be obtained from the telegram per cycle -> **dedicated timing card**
 - Memory for 32 users will be reserved.



Beam Permit Logic

- System [HW and/or SW] will **block** injections
 - i.e. “remove permit” if losses over threshold
- System [SW] will **remember** if the user is allowed to have beam
 - i.e. “give permit” if previous cycle for the user was ok (or previous interlocks were cleared)
- The Beam Interlock Controller will be configured in the “Non-latch” mode.
 - i.e. the system will need to follow timing and notify in advance.
- Aiming to keep the maximum **latency** (from measurement to output) small
 - HW: The target for the fast integration periods is ~ 5 μ s
 - SW: Block on next cycle
- Only data from the **current cycle** need to be considered.
 - Timing in the electronics essential (i.e. possible failure mode)



Ambient Radiation Measurement

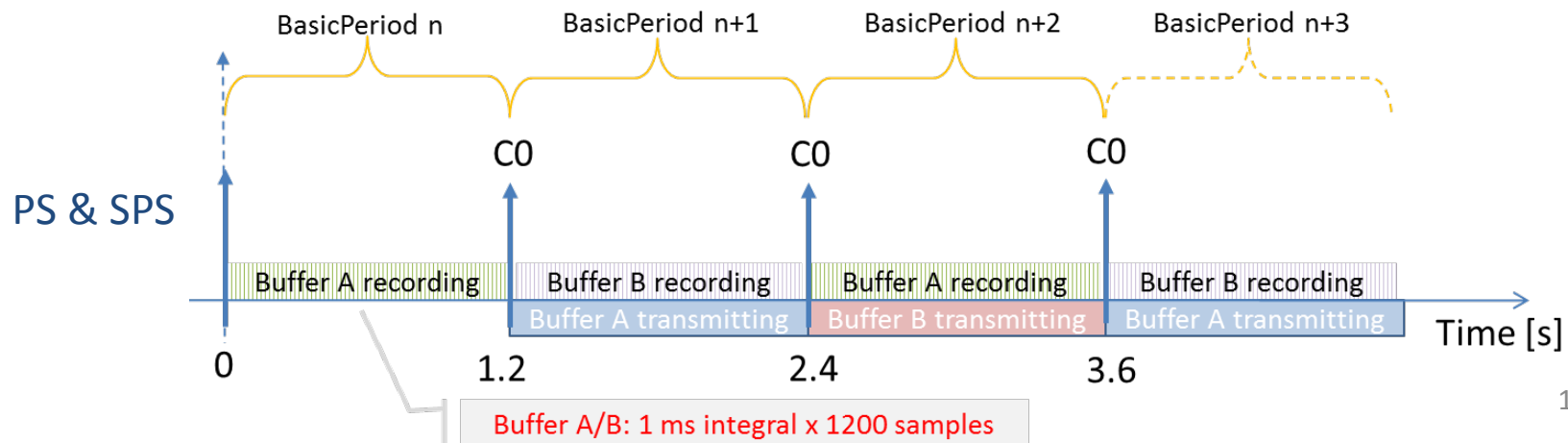
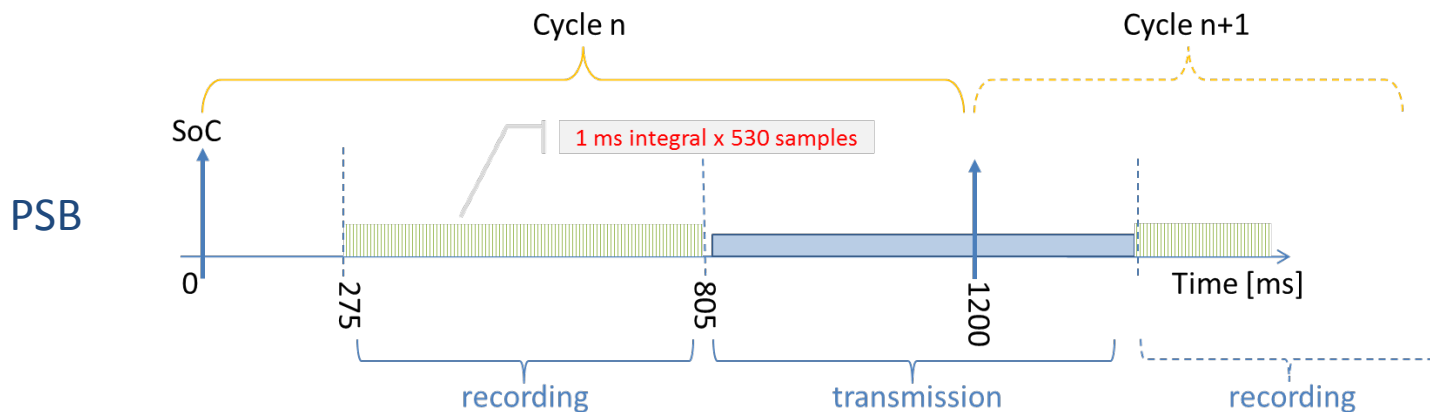
Calculate and log the ambient radiation measured at each cycle

- Processing electronics will provide two values:
 - total accumulated in the cycle (already described) and
 - total accumulated with beam present
- Subtraction of the two values in CPU
- Additional timing events to be used for the recording
- Values will come together with number of samples used in the recording to allow accurate conversion to user-friendly units, i.e. Gy, Gy/s, ...
- Publish values for the online displays and the long-term logging



Evolution Over Time buffer

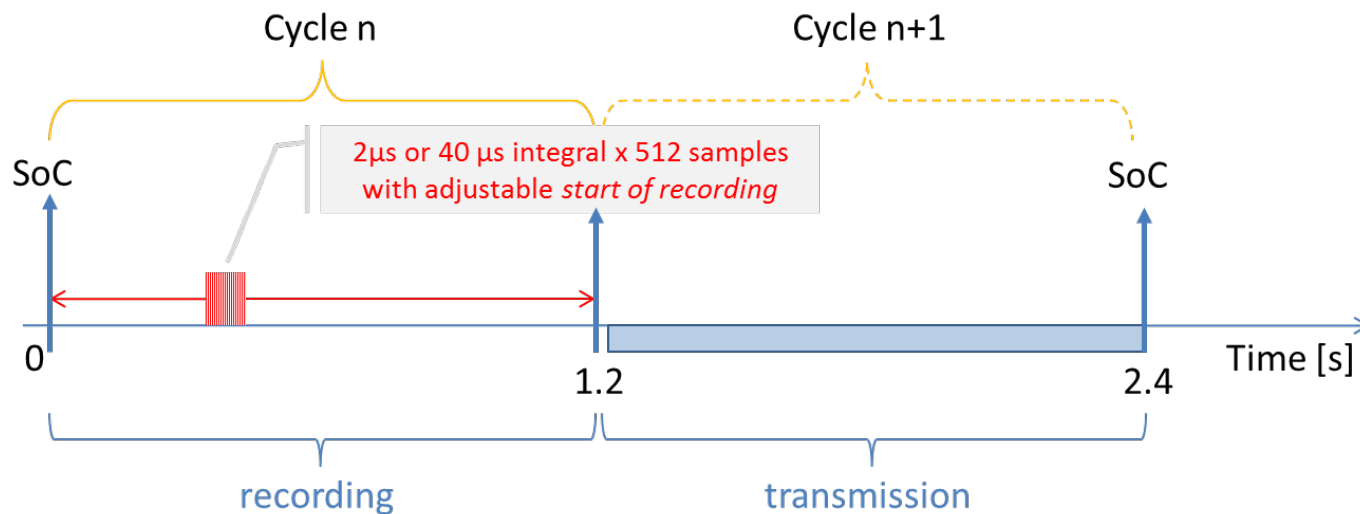
- The system will continuously record multiple consecutive values from each detector over a predefined period.
 - Publish on the online displays and logging on demand





Capture function for PSB & PS

- The system will publish on-demand high resolution time evolutions of the beam losses for each detector.

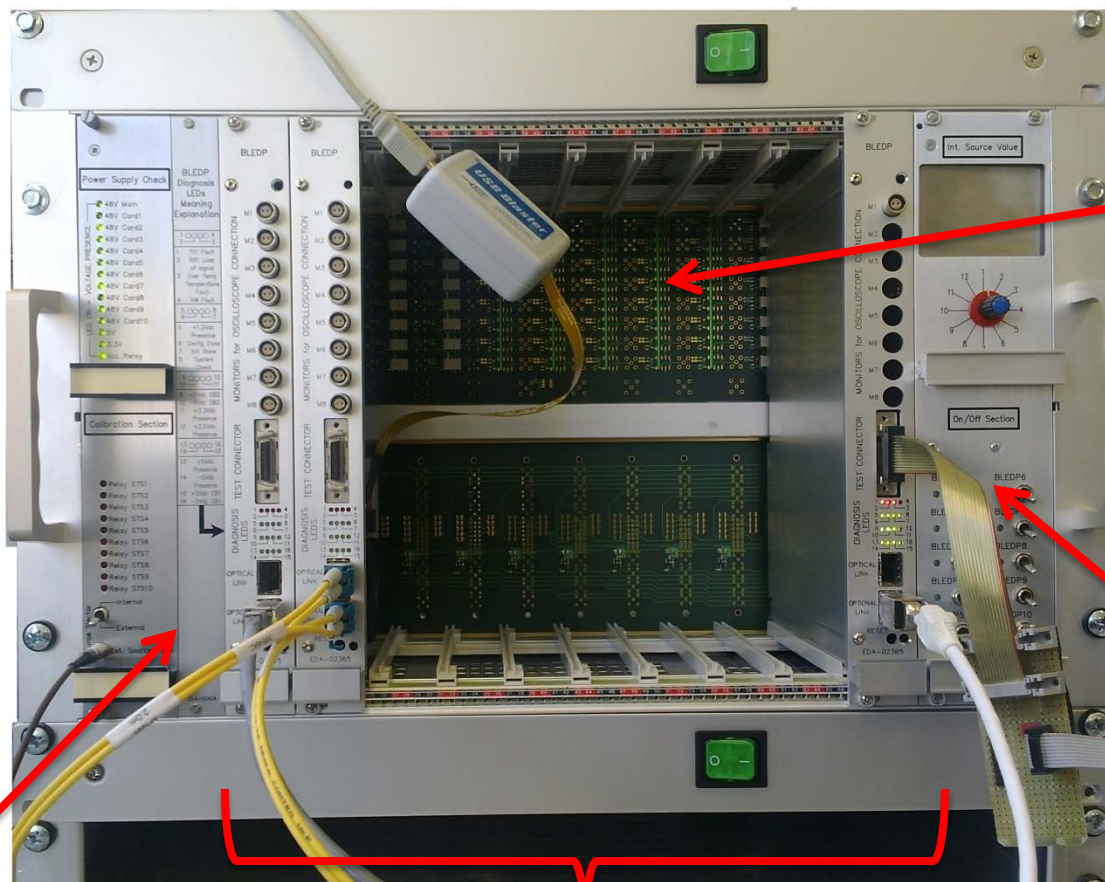




Status of Development



Acquisition Crate



Custom Backplane
Support 64
connectors and
relays for the input
channels and
distribute signals

Control Unit
Later version w/
advanced remote
functions

Main panel

- Ref. current Input
- LEDs
- Power switch

Acquisition module (BLEDP)

Up to 8 modules with
8 channel each



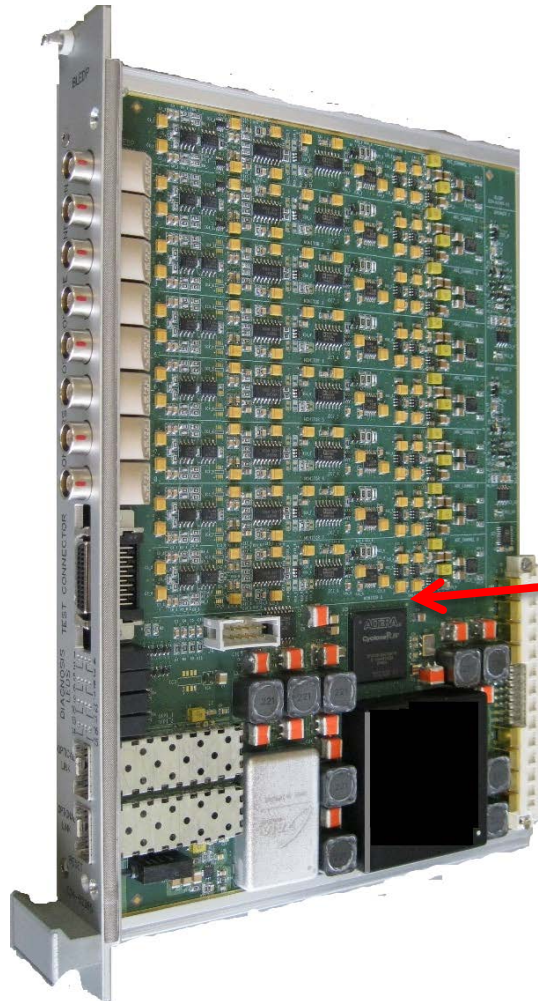
Acquisition module (BLEDP)

Completed verification
of version 2 of the
printed circuit board

Completed design of
version 3.
- Noise reduction

JTAG connection
Local programming
and diagnostics

SFP connectors
Gigabit optical and/or
Ethernet links



Acquisition
digitisation of 8
channels

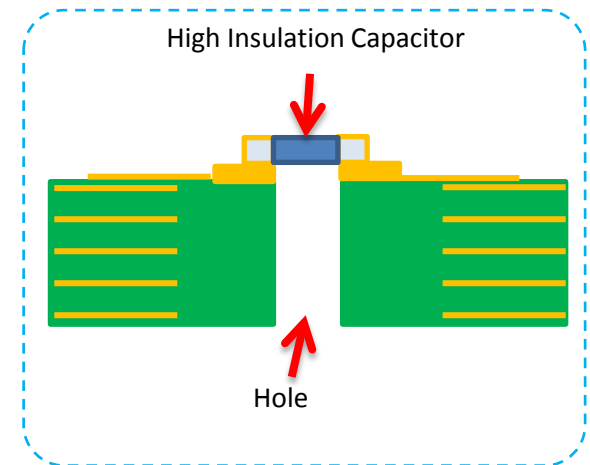
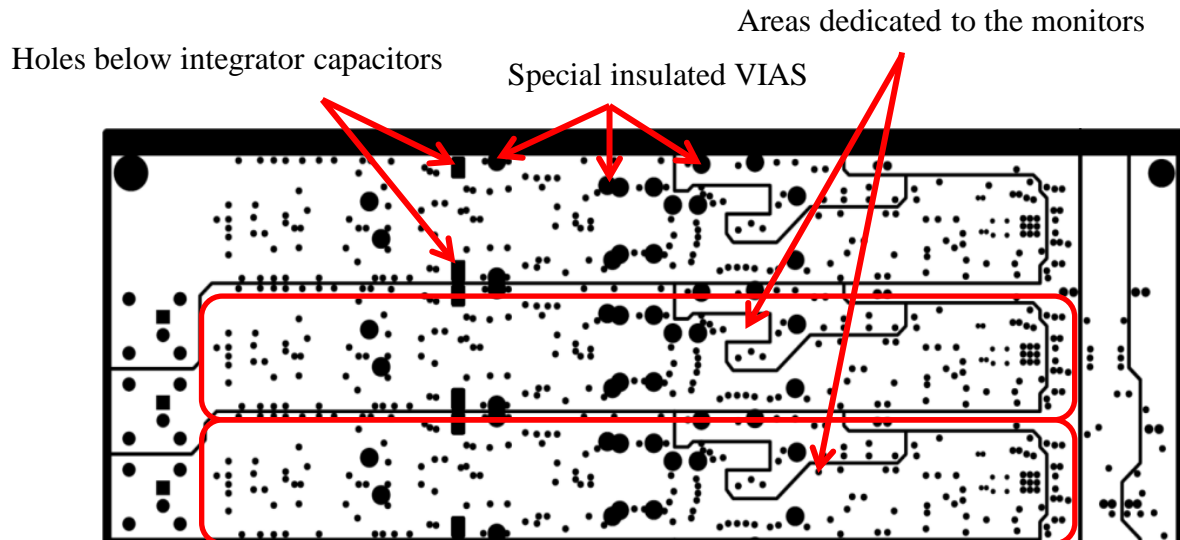
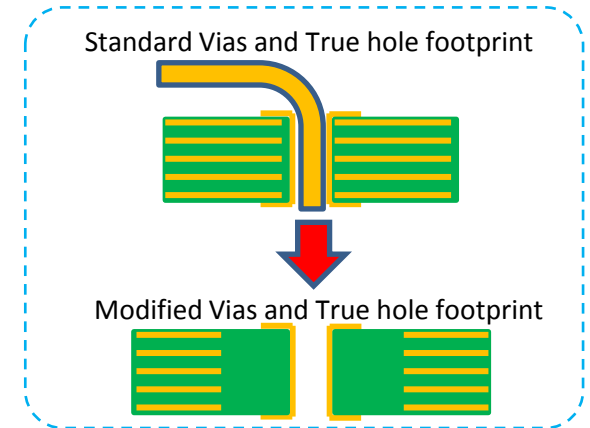
FPGA
Altera Cyclone IV

Backplane connection
Analogue inputs, power
and control



Acquisition module (BLEDP)

- Improve the insulation between input lines and other signals e.g. power supplies.
- This has been done by:
 - creating special VIAS,
 - optimising routing paths and
 - creating holes below the integration capacitor.
 - several ground areas have been created.





Status of Development

- Production and assembly of many parts completed





Status of Development

PCB Development

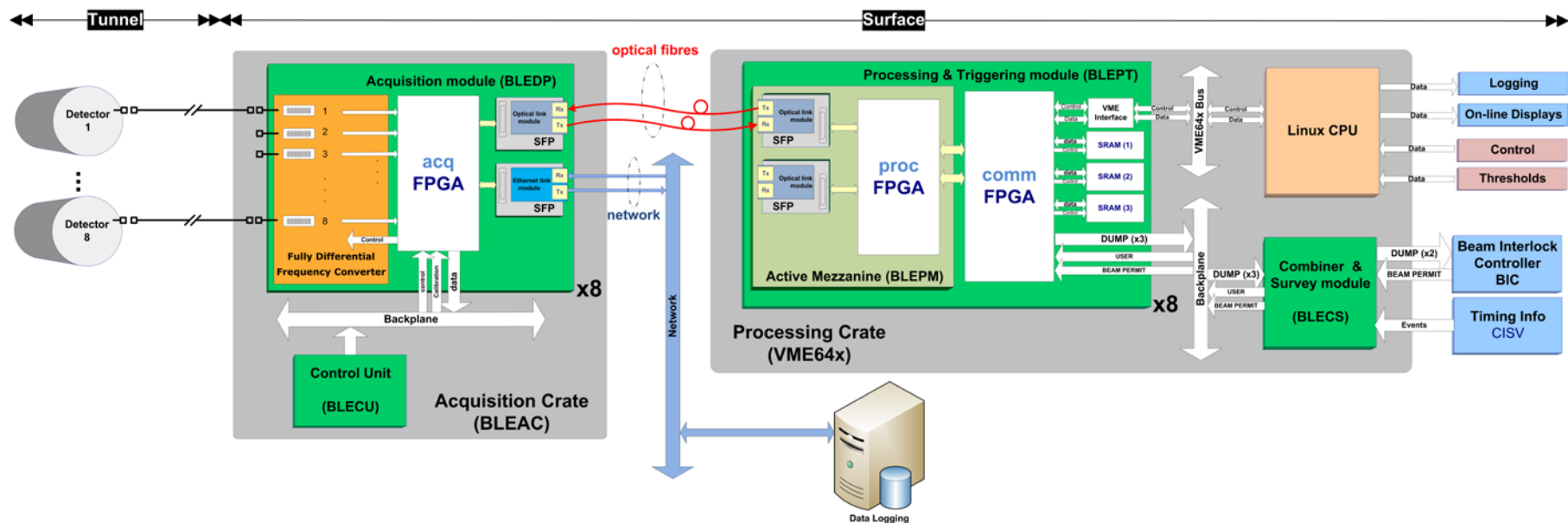
- All prototypes verified and functional.
- Pre-Series production will need to cover needs till LS2.
- Contracts for the Acquisition and Mezzanine modules ready – to be launched around Nov 2013.

| Name | Acronym | Number of Components | 2010 | 2011 | 2012 | 2013 | 2014 | 2016/7 |
|---------------------------|---------|----------------------|---------------------------|----------------------------|----------------------------|----------------------------|-----------------------------|---------------------------------|
| | | | Prototype Development | | | Pre-Series | | Series |
| Acquisition Module | BLEDP | 1934 | First Prototype (1 piece) | V1.0 (2 pieces) | V2.0 & V2.1 (3 pieces) | - | Production V3.0 (20 pieces) | Production V3.x (60-100 pieces) |
| Acquisition Backplane | BLEBP | 1173 | - | V1.0 (2 pieces) | V2.0 (1 piece) | Production V3.0 (7 pieces) | - | Production V3.0 (10-15 pieces) |
| Processing Mezzanine | BLEPM | 210 | - | V1.0 (1 piece) | - | - | Production V2.0 (20 pieces) | Production V2.x (60-100 pieces) |
| Crate Main Panel | BLEMP | 52 | - | First Prototype (2 pieces) | V1.0 (2 pieces) | Production V2.0 (7 pieces) | - | Production V2.0 (10-15 pieces) |
| Crate Control Unit | BLECU | 180 | - | First Prototype (1 piece) | Second Prototype (1 piece) | Production V1.0 (7 pieces) | - | Production V1.0 (10-15 pieces) |
| Acquisition Crate | BLEAC | 200 | - | First Prototype (1 piece) | V1.0 (2 pieces) | Production V2.0 (7 pieces) | - | Production V2.0 (10-15 pieces) |
| Crate Programmer | BLEJP | 160 | - | - | First Prototype (1 piece) | Production V1.0 (7 pieces) | - | Production V1.0 (10-15 pieces) |
| High Voltage Distribution | BLEHV | 100 | - | - | - | Production V1.0 (7 pieces) | - | Production V1.0 (10-15 pieces) |



Status of Development

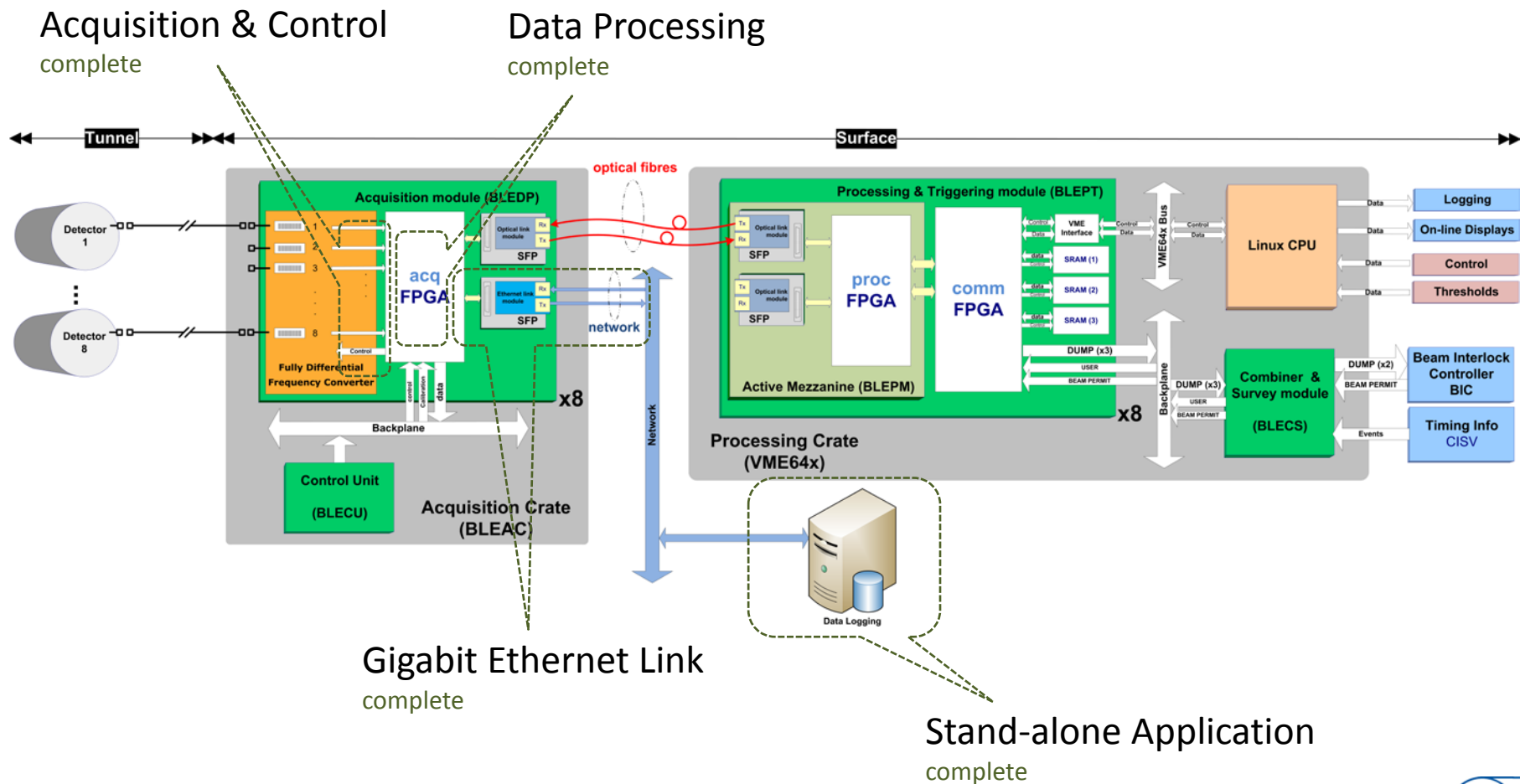
System Overview





Status of Development

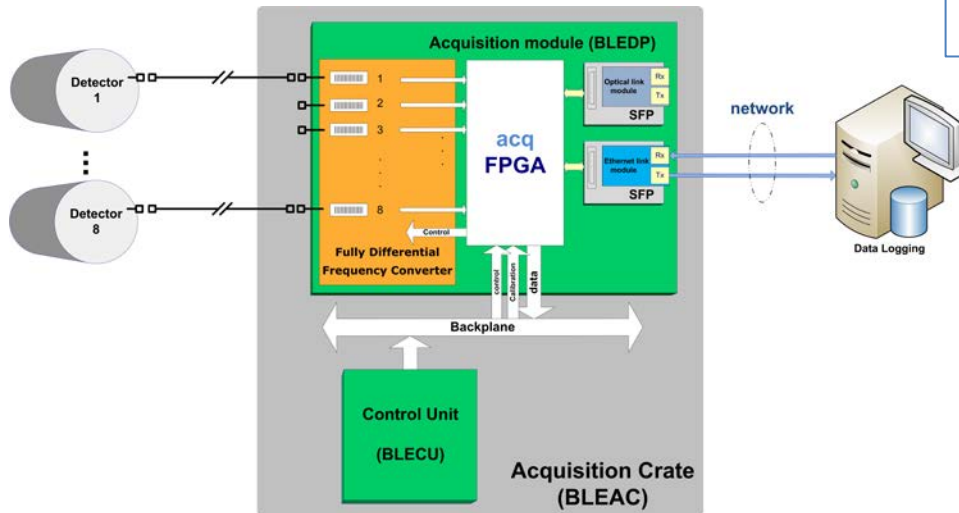
FPGA Development



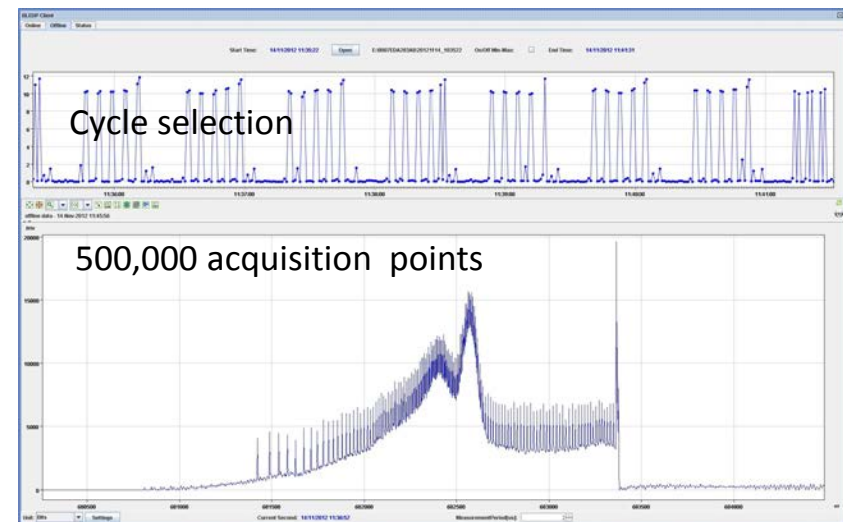


Status of Development

FPGA Development



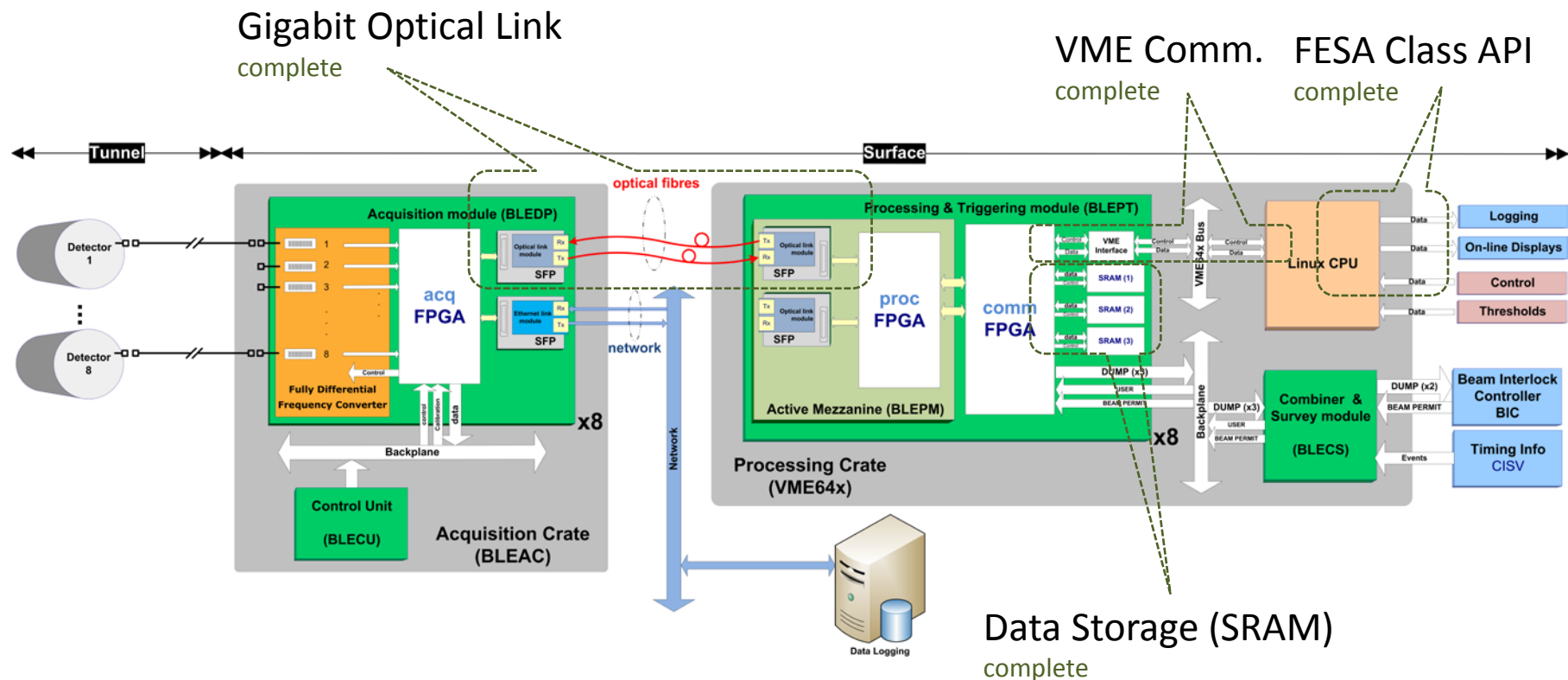
- Ethernet-based version of the system ready
- Very powerful for
 - verification,
 - commissioning and
 - fine observations





Status of Development

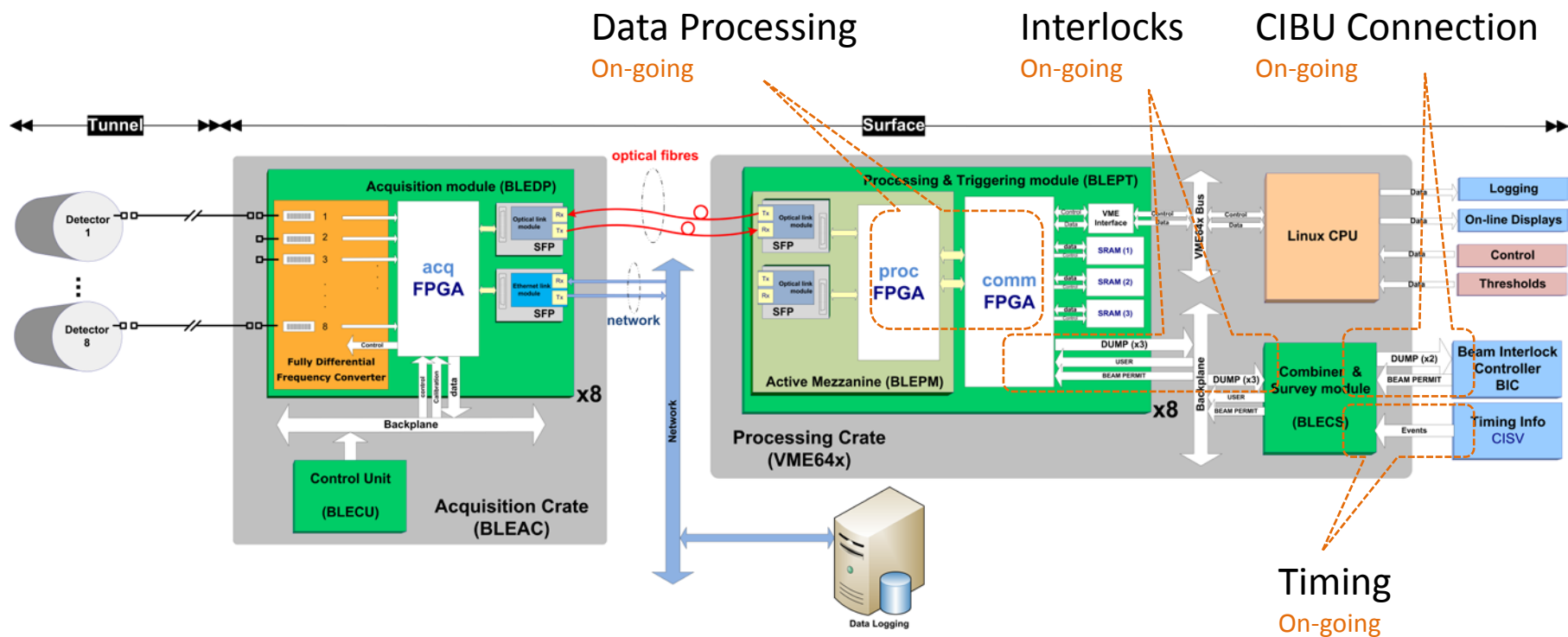
FPGA Development





Status of Development

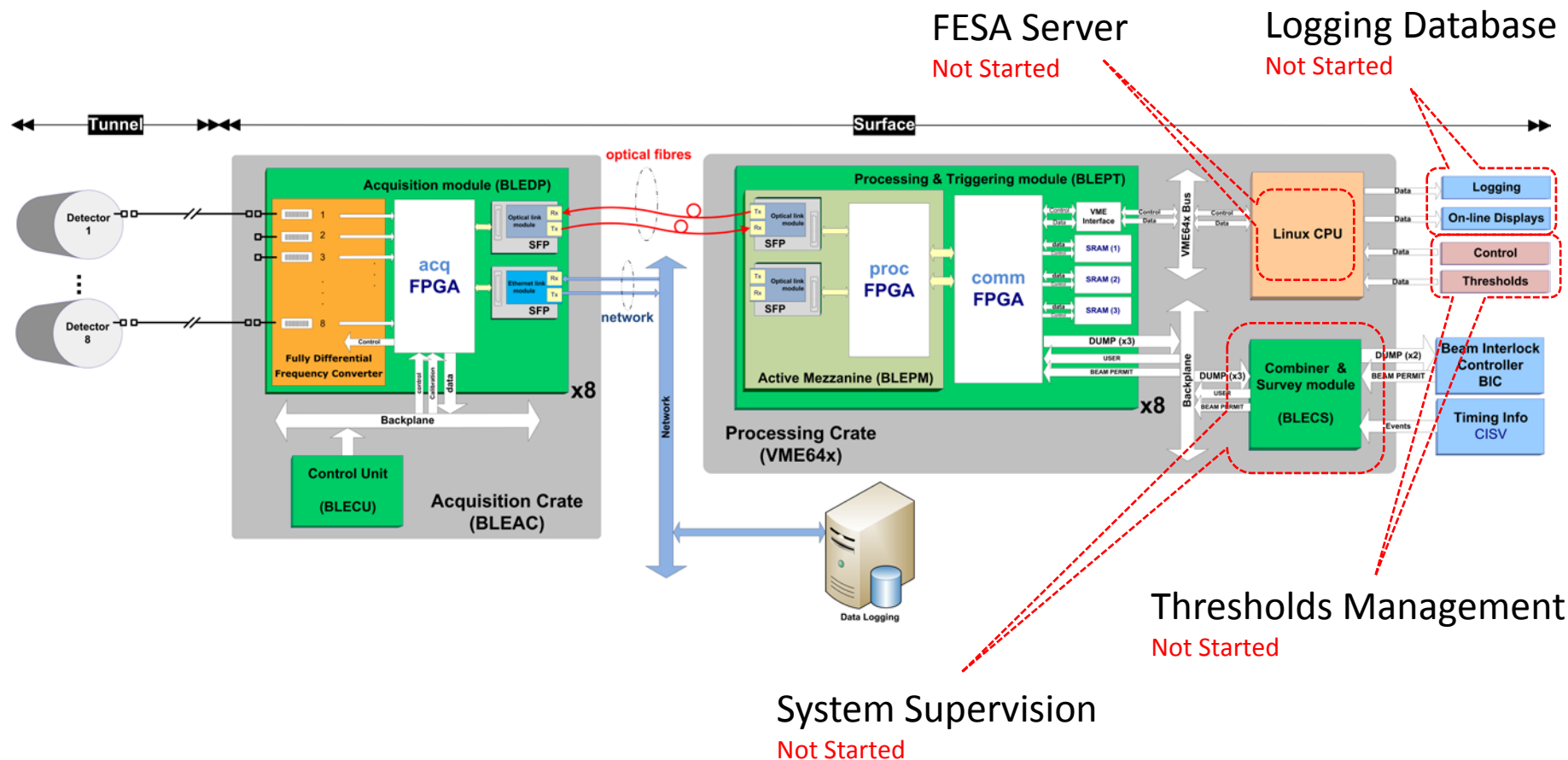
FPGA Development





Status of Development

FPGA Development





Installation and Commissioning Plan



Installation and Commissioning Plan

Racks

- **PSB Ring:** completed
 - Floor supports have been designed and installed
 - Rack installed
- **PSB Injection & Extraction:** on-track
 - Floor supports have been designed and installed
 - Positions defined
- **PS Ring and Transfer Lines:** not yet planned
 - Identified candidate buildings and positions
- **SPS Ring & Transfer Lines:** not yet planned
- **SPS TT10:** not yet planned
 - Identified candidate buildings and positions



Signal Cable panel &
HV distribution

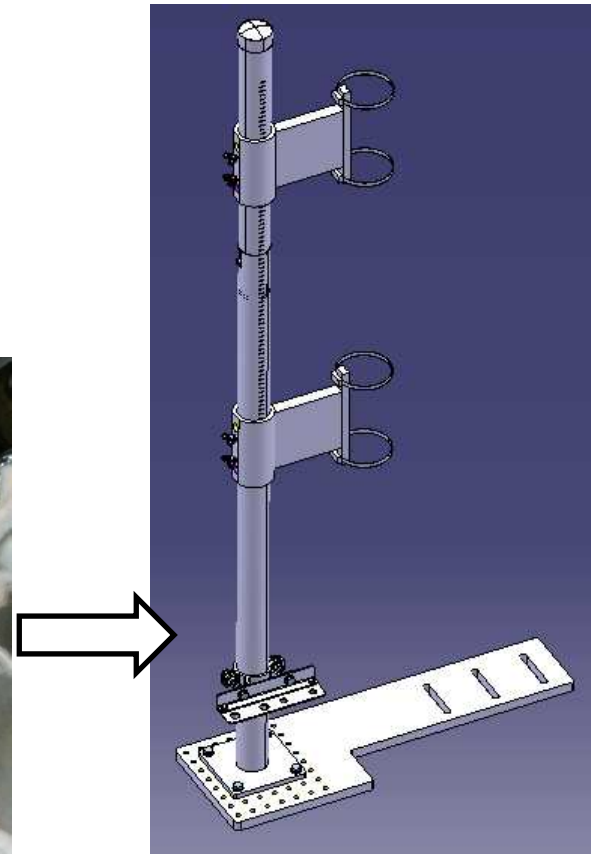


Installation and Commissioning Plan

- PSB Ring detector support



Prototype support to check integration



3D version by EN/MME
V. Valganon & N. Chritin



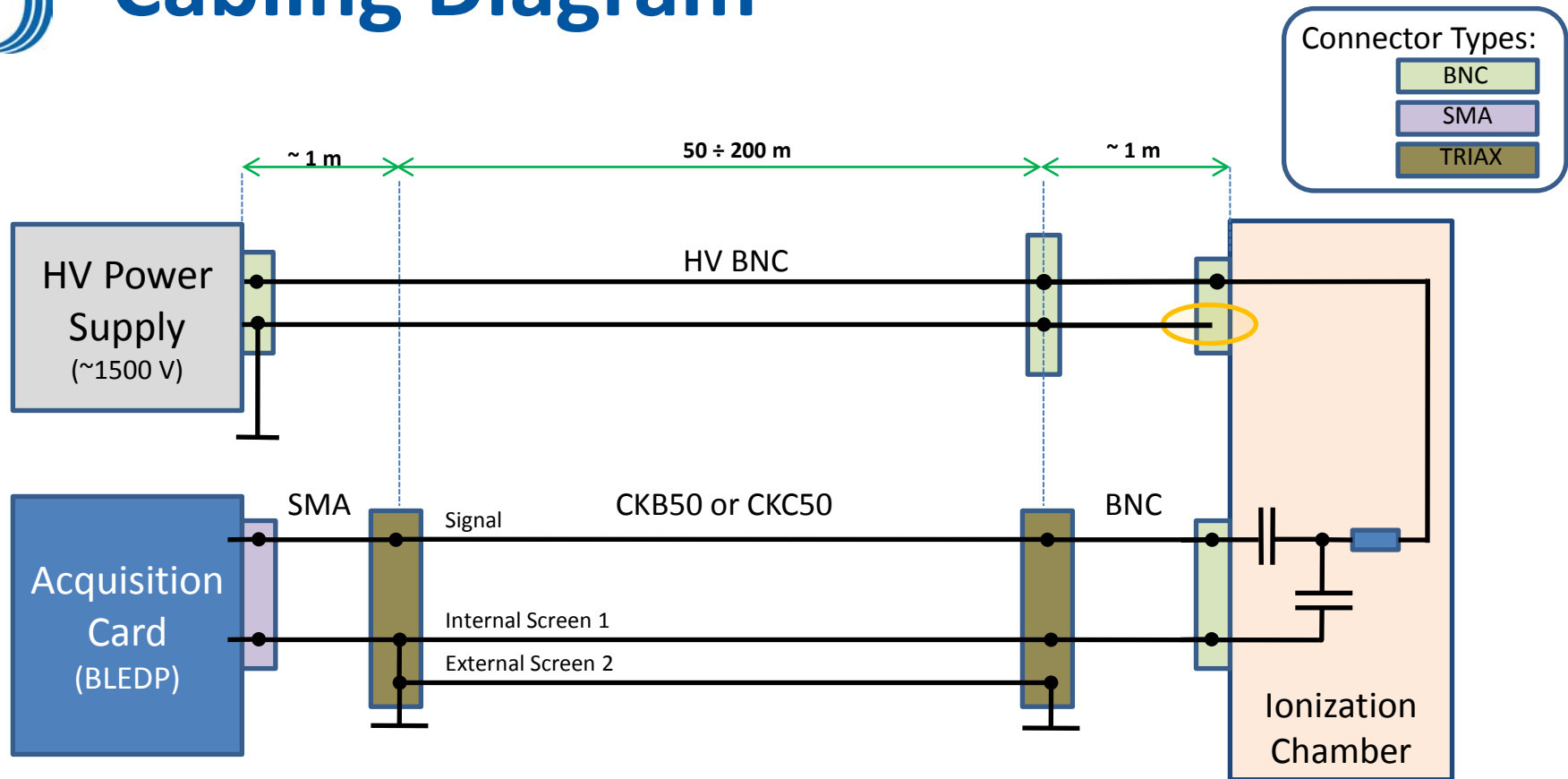
Installation and Commissioning Plan

Detector Supports

- **PSB Ring:** design complete
 - Prototype is being constructed by the workshop.
 - Production to complete end of Nov. 2013
- **PSB Injection & Extraction:** not available
 - Design to start towards the end of the year (2013)
- **PS Ring and Transfer Lines:** not yet planed
- **SPS Ring:** not needed/keep current installation
- **SPS TT10:** not yet planned



Cabling Diagram



- Screen of HV BNC is open on the IC side to assure there is **no ground loop**.
- Internal screen to **shield low frequency** noise (GND only on electronics side, IC is floating).
- External screen to **shield high frequency** noise.



CKC50 Cable production

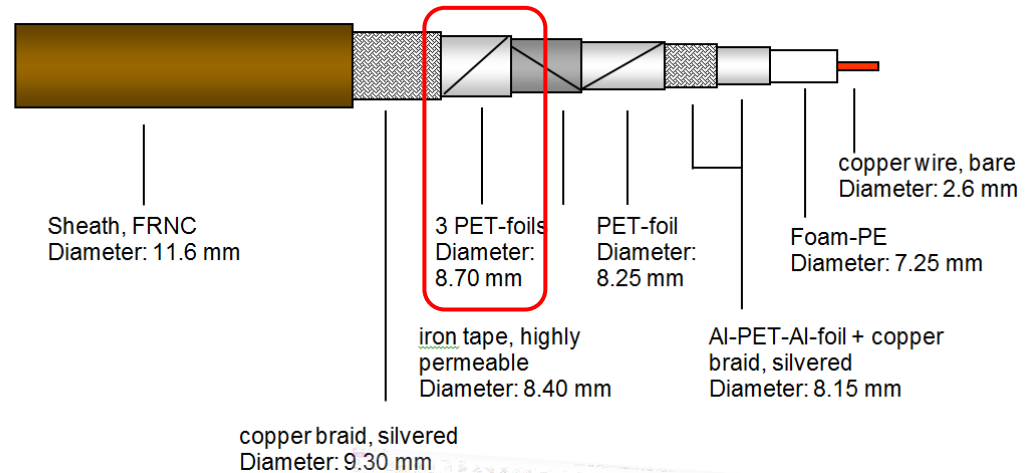
CKB50



- At random positions discovered shorts between the two shields.
- Not usable for **Triaxial** functionality.



CKC50



- New cable (CKC50) production agreed with manufacturer:
 - Modification of the CKB50 specs: Additional PET-foils over the magnetic screen. (Avoided problems mounting the connector. The electrical properties will not change.)
 - Manufacturer to run a **trial production** and testing until end of September
 - We will test the sample and release the cable by mid-October
 - If all ok, will manufacture about 6km until end of November
- Re-installation to begin in PSB from January 2014 (6-8 weeks).
 - Some conflict with Injectors 2014 schedule.

← We are here



Budgetary Requirements



Budgetary Requirements - PSB

- Updated general cost breakdown up until 2019

| LIU-PSB | 2011 | 2012 | 2013 | 2014 | 2015 | 2016 | 2017 | 2018 | TOTAL LIU (kCHF) |
|-------------------------|----------|----------|-----------|-----------|------------|------------|----------|----------|------------------|
| Ring (L2 position) | | | 90 | | | | | | 90 |
| Injection & BI Line | | | | | 52 | 49 | | | 101 |
| Injection (observation) | | | | | 110 | 37 | | | 147 |
| Ring (L3 position) | | | | 50 | | 123 | | | 173 |
| Extraction | | | | | 80 | 80 | | | 160 |
| TOTAL LIU (kCHF) | 0 | 0 | 90 | 50 | 242 | 289 | 0 | 0 | 671 |

- Summary of differences on the updated general cost

| PSB | original (kCHF) | updated (kCHF) | Diff | Charged | | |
|-------------------------|-----------------|----------------|------------|---------|-------------|---------------|
| | | | | cables | electronics | monitors |
| Ring (L2 position) | 90 | 90 | 0 | LIU | CONS | spares |
| Injection & BI Line | 65 | 101 | 36 | LIU | LIU | spares |
| Injection (observation) | 77 | 147 | 70 | LIU | LIU | LIU (Diamond) |
| Ring (L3 position) | 40 | 173 | 133 | LIU | CONS | LIU (Flat IC) |
| Extraction | 0 | 160 | 160 | LIU | LIU | spares |
| TOTAL LIU (kCHF) | 272 | 671 | 399 | | | |



Budgetary Requirements - PS

- Decision needed about the strategy to follow

- Original plan:

- Keep current detectors
- Keep cables
- New electronics (CONS)

| LIU-PS | detectors | electronics | installation | TOTAL (kCHF) |
|--------------------|-----------|-------------|--------------|--------------|
| Ring | 0 | 272 | 0 | 272 |
| Ring (observation) | 0 | 0 | 0 | 0 |
| Transfer Lines | 0 | 100 | 0 | 100 |
| TOTAL (kCHF) | 0 | 372 | 0 | 372 |

- New request (draft):

- Replace & 40 new detectors
- New cables
- New electronics
- New Observation system
- System for FTA & FTN lines

| LIU-PS | detectors | electronics | installation | TOTAL LIU (kCHF) |
|--------------------|-----------|-------------|--------------|------------------|
| Ring | 160 | 272 | 290 | 722 |
| Ring (observation) | 490 | n/a | 145 | 635 |
| Transfer Lines | 84 | 140 | 515 | 739 |
| TOTAL LIU (kCHF) | 734 | 412 | 950 | 2096 |



Budgetary Requirements - SPS

- Estimated general cost up until 2019

| LIU-SPS | detectors | electronics | installation | TOTAL LIU (kCHF) |
|-----------------------|-----------|-------------|--------------|------------------|
| Ring & Transfer Lines | 0 | TBD | TBD | ??? |
| TT10 | 50 | 150 | 500 | 700 |
| TOTAL LIU (kCHF) | 50 | 150 | 500 | 700 |

- SPS Ring and Transfer Lines:
 - Reuse detectors
 - New electronics under development
 - Cables or fibres will be dictated by electronics design.
- TT10: (new system)
 - 30 LHC-IC type detectors
 - Standard electronics, two racks
 - Long cables



General Planning



General Planning - PSB

| Machine/Area | | Channels | Documentation | Detectors | Electronics | Installation & Commissioning | Budget | Expected |
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| | Injection & BI Line | 18 | Complete | LIC | Pre-series | Initialising plan | Incomplete | L4C |
| | Injection (observ.) | 8 | Complete | Diamond | TBD | Initialising plan | Incomplete | L4C |
| | Ring (L3 position) | 32 | Complete | FIC | Series | Not started | Incomplete | LS2 |
| | Extraction | 28 | Complete | LHC-IC | Series | Not started | Incomplete | LS2 |

Plans for **LS1** & **LINAC4 Connection** are clear and agreed

- Update of budget needed (times and amounts).
- Will validate pre-series version of electronics with beam
 - Series production towards the end of 2016
- Development of **Firmware and Software** will continue after LS1
 - FESA server, Threshold Management, Logging DB, Controls integration
- Additional **cables and monitors** could be installed during LINAC4 Connection
 - Add electronics in the surface when available.
- Diamond based system's acquisition electronics under study
 - Pursuit more actively after LS1



General Planning – PS & SPS

| Machine/Area | | Channels | Documentation | Detectors | Electronics | Installation & Commissioning | Budget | Expected |
|--------------|--------------------|----------|----------------|-----------|-------------|------------------------------|----------------|----------|
| PS | Ring | 100 | Only positions | LHC-IC | Series | Not started | Unallocated | TBD |
| | Ring (observation) | 40 | Only positions | Diamond | TBD | Not started | Unallocated | TBD |
| | Transfer Lines | 51 | Only positions | LHC-IC | Series | Not started | Unallocated | TBD |
| SPS | Ring & Tr. Lines | 500 | Advanced | SPS-IC | TBD | Not started | to be verified | LS3 |
| | TT10 | 30 | Complete | LHC-IC | Series | Not started | Unallocated | TBD |

Plans for **LS2** and beyond need input and budgets (incl. manpower).

- PS: need to define strategy and specifications
 - Large system - need to consider manpower
 - Diamond based system: Cables and Detectors could be installed during L4C or LS2.
- SPS Ring & Transfer Lines:
 - Preferred solution is the BLM-ASIC with fibres
 - Results from second version of the ASIC not yet available
- SPS TT10: if budget/manpower is available
 - Cables and Detectors could be installed during L4C or LS2.
 - Use standard version of the electronics when available.
- Possible conflict: Major renovation of the LHC system during LS2



LHC Injectors Upgrade

THANK YOU FOR YOUR ATTENTION!

